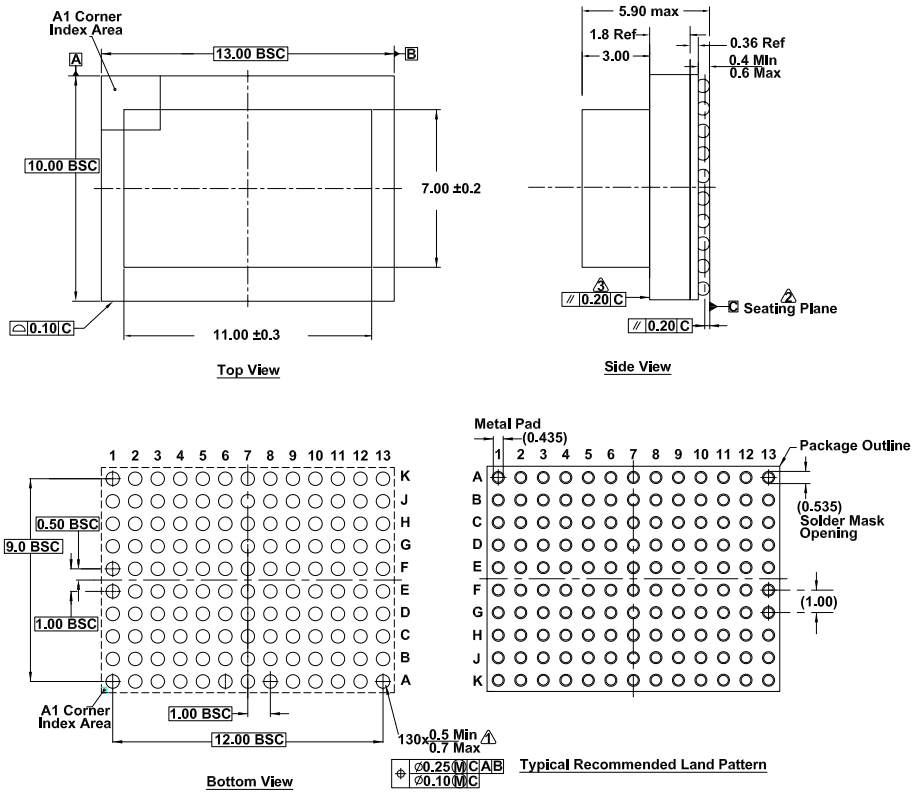
Package Outline Drawing

V130.10x13A

130 Ball Plastic Ball Grid Array Package (POP)
Rev 0, 7/2022



Notes:

1. Dimension is measured at the maximum solder ball diameter, parallel to primary datum C.
2. Datum C (seating plane) is defined by the spherical crowns of the solder balls.
3. Parallelism measurement shall exclude any effect of the mark on the top surface of the package.
4. All dimensions and tolerances conform to ASME Y14.5M.
5. Units: mm